



Electronic Materials Lab

ADDRESS

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EDUCATION

- 1990– 1995, M.S. and Ph.D in Electroceramic Thin Films, Korea Advanced Institute of Science & Technology (KAIST), Korea
- 1986– 1990, B.S. in Materials Science & Engineering Korea Advanced Institute of Science & Technology (KAIST), Korea

RESEARCH EXPERIENCE

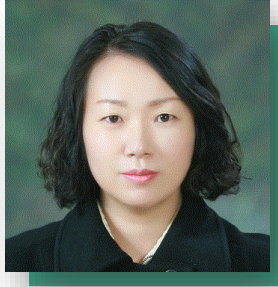
- 2002 – Present, Dong-Eui University, Busan, Korea
Professor, Department of Mat. Components Eng. & Electronic Research Center (ECC)
- 2009 – 2010, University of Maryland at College Park, MD, USA
Visiting Scholar, AZO films by Atomic Layer Deposition (ALD) and characterization of their electrical properties for TCO application.
- 1997 – 2002, Electronics and Telecommunications Research Institute (ETRI), Daejeon, Korea
Senior Research Engineer, ETRI-Micro-Electronics Technology Lab.
- 1996 – 1997, North Carolina State University, Raleigh, NC, USA
Post-doctor, Department of Materials Science and Engineering
Process development of BST films using a liquid delivery source MOCVD process

MAIN RESEARCH AREAS

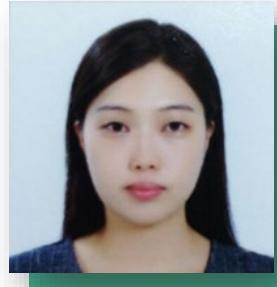
- SiC Single Crystal & epitaxial growth by PVT method and their characterization as a wafer.
- GaN wafer fabrication by HVPE technique.
- ZnO thin films deposited by pulsed laser deposition (PLD) technique
- Dielectric layers grown by plasma enhanced atomic layer deposition (PEALD) process.
- International Journals; 160, Patents; 50

Member

Researcher



Yeon-Suk Jang
Single crystal growth
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Single crystal analysis
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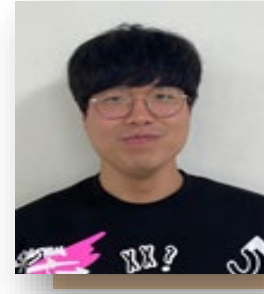
Master's Candidate



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SiC single crystal growth
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Seung-Jun Lee (2st year)
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Tae-Wan Je (1st year)
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Undergraduate Student



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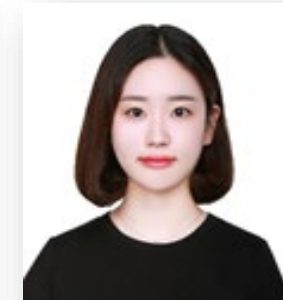
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Su-Min Choi (Senior)
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Hui-Yeon Jang (Senior)
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Electronic Material Lab

Main Research Area

- Single Crystal Growth of Compound Semiconductor
- Electronic Ceramics
- Ceramic Thin Film / Component
- Wafer Processing and Analysis
- Numerical Simulation

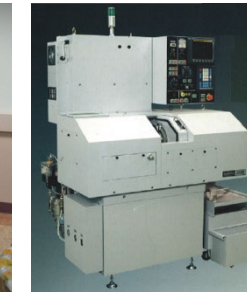
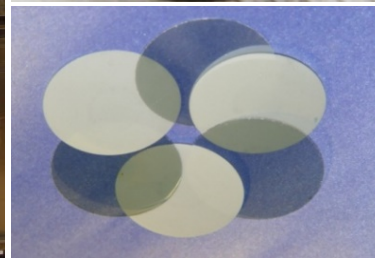
Overview

Crystal Growth

- Single crystal growth of various materials used in semi-conductor or display by Sublimation Growth or Solution Growth
 - SiC, AlN, Semi-insulator SiC
- Epitaxial growth on substrate using PVD or CVD
 - GaN, ZnO, TiO₂, SiC, Ga₂O₃

Processing (Wafering)

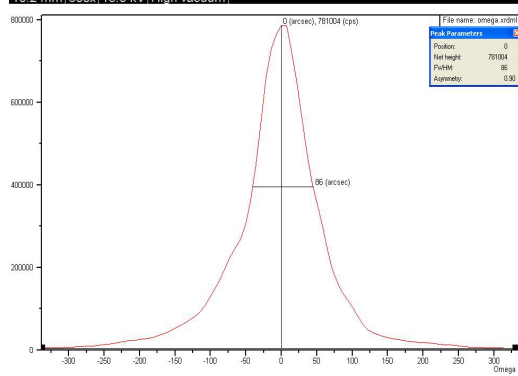
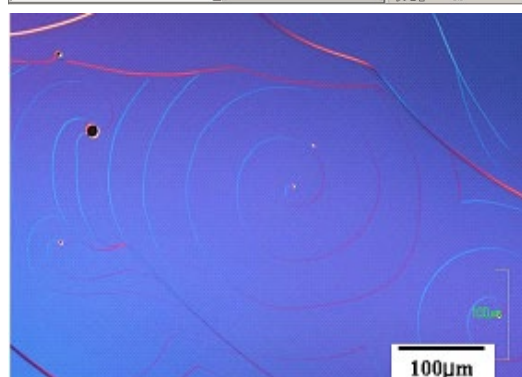
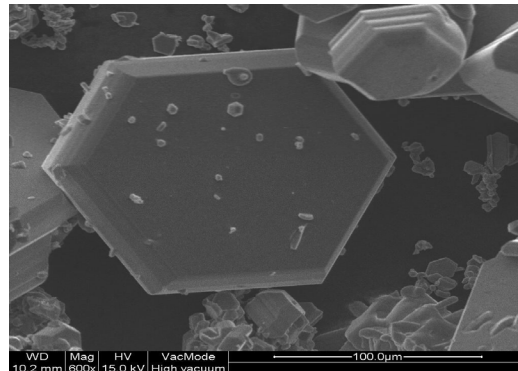
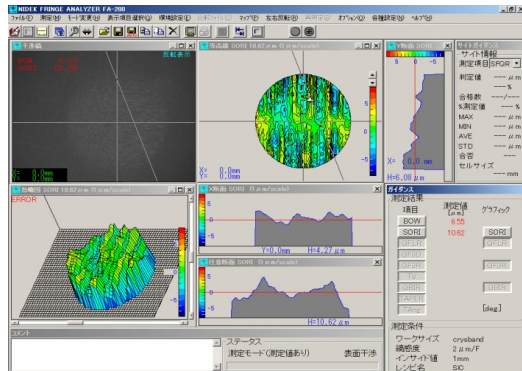
- Equipped to process grown ingot into wafers (Wafering)
- Cutting : Multi-Wire Saw, Single-Wire Saw, Blade Cutter
- Surface : Grinder, Lapping, DMP, CMP
- Others : Lateral Grinder, Edge Grinder, Seeding Equipment, Plasma Etcher



Overview

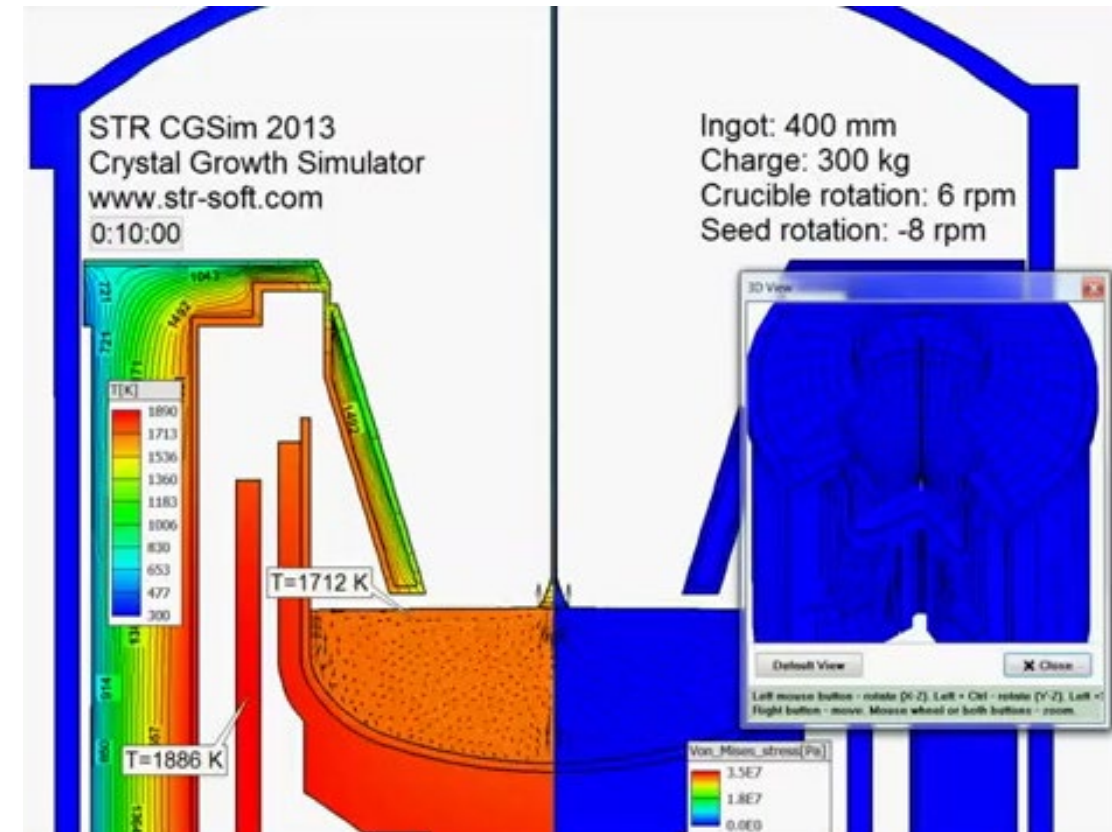
Analysis

- Analyzing crystallographic quality and defect of single crystal
 - XRD, HR-XRD, Goniometer
- Surface quality analysis
 - OM, AFM, Wetting Angle, SEM /EDS
- Electrical properties analysis
 - Hall measurement, UVF



Simulation

- Optimization of experiment condition by simulating a single crystal growth to predict temperature distribution, growth rate and fluid flow
 - CGSim, Virtual Reactor



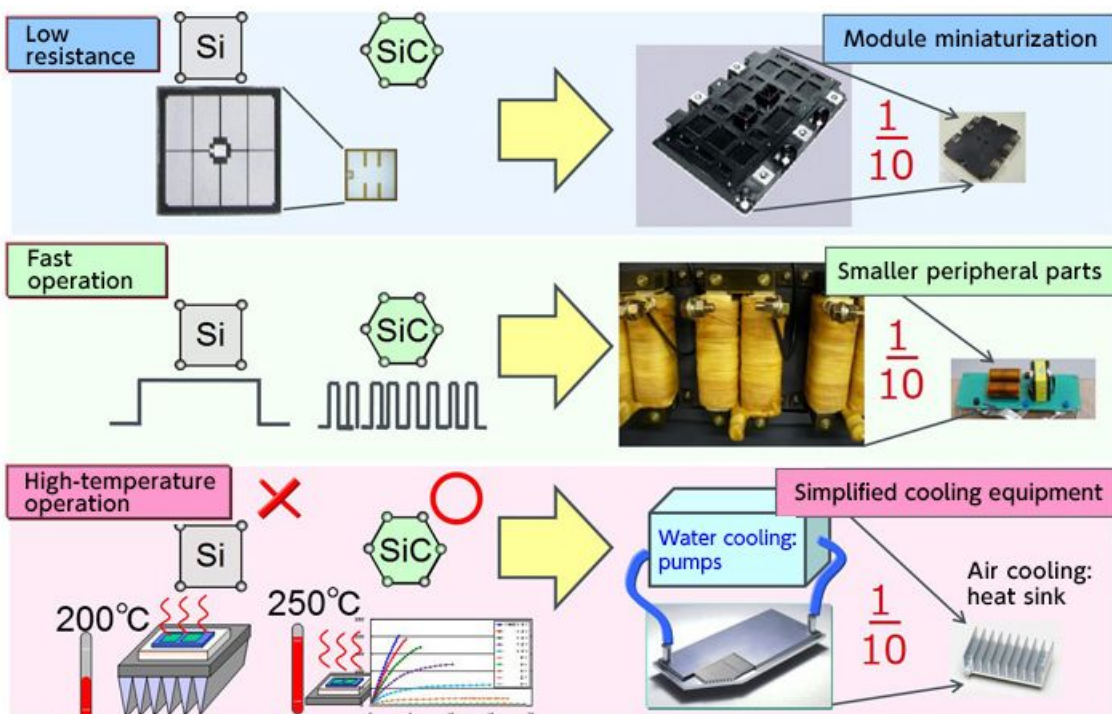
[Ref.] STR Group, www.str-soft.com

SiC Single Crystal

SiC

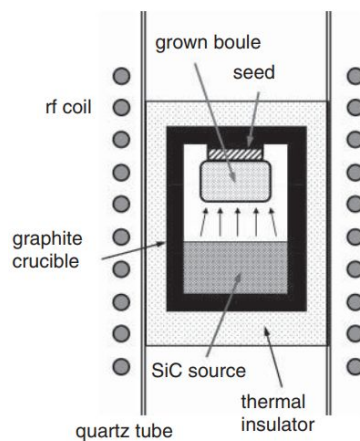
- SiC (Silicon Carbide) is a promising substrate applicable to power device working at high power, high frequency and high temperature.

Advantage

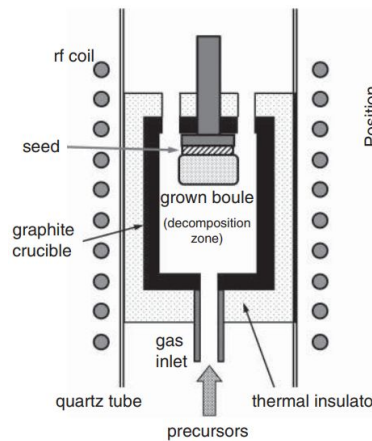


[Ref.] Tech web, <https://micro.rohm.com/en/techweb/knowledge/sic/s-sic/02-s-sic/4161>

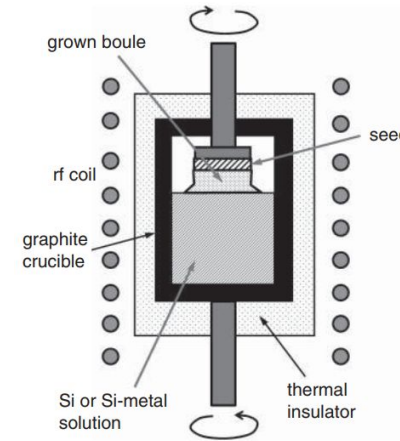
PVT



CVD

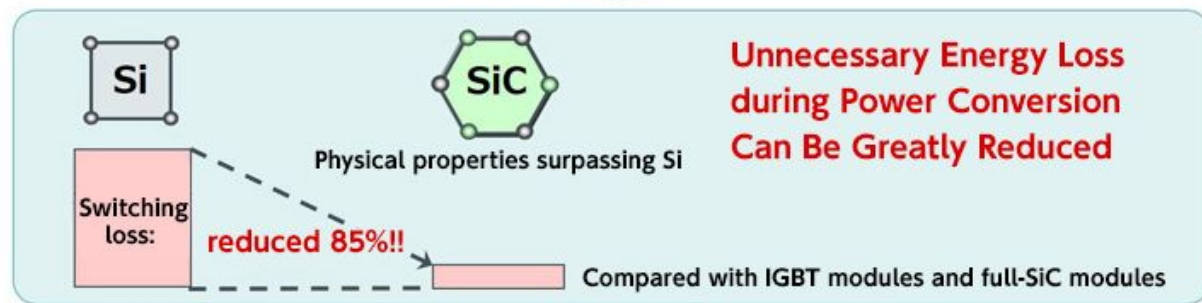
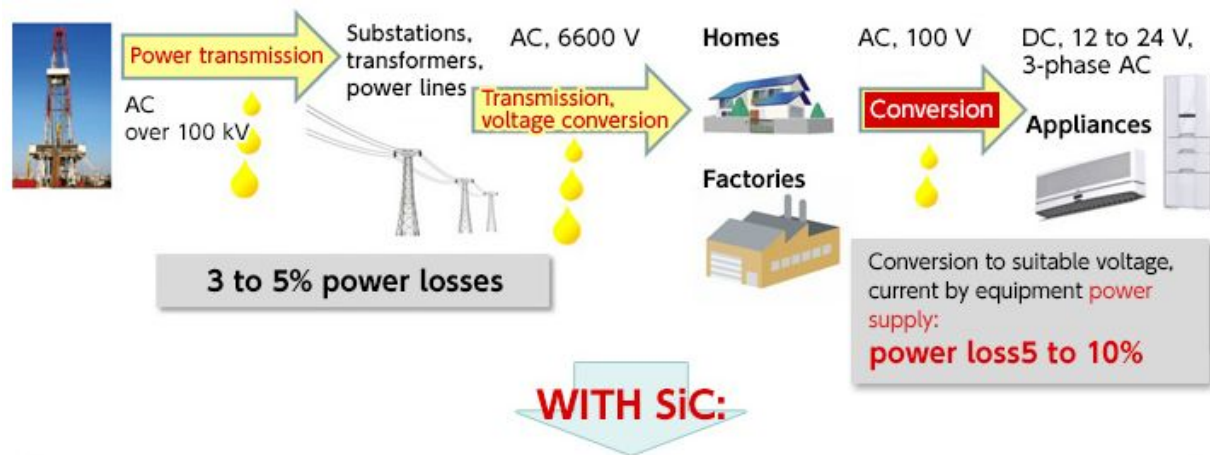


TSSG



[Ref.] Fundamentals of Silicon Carbide Technology_ Growth, Characterization, Devices and Applications-Wiley-IEEE Press (2014)

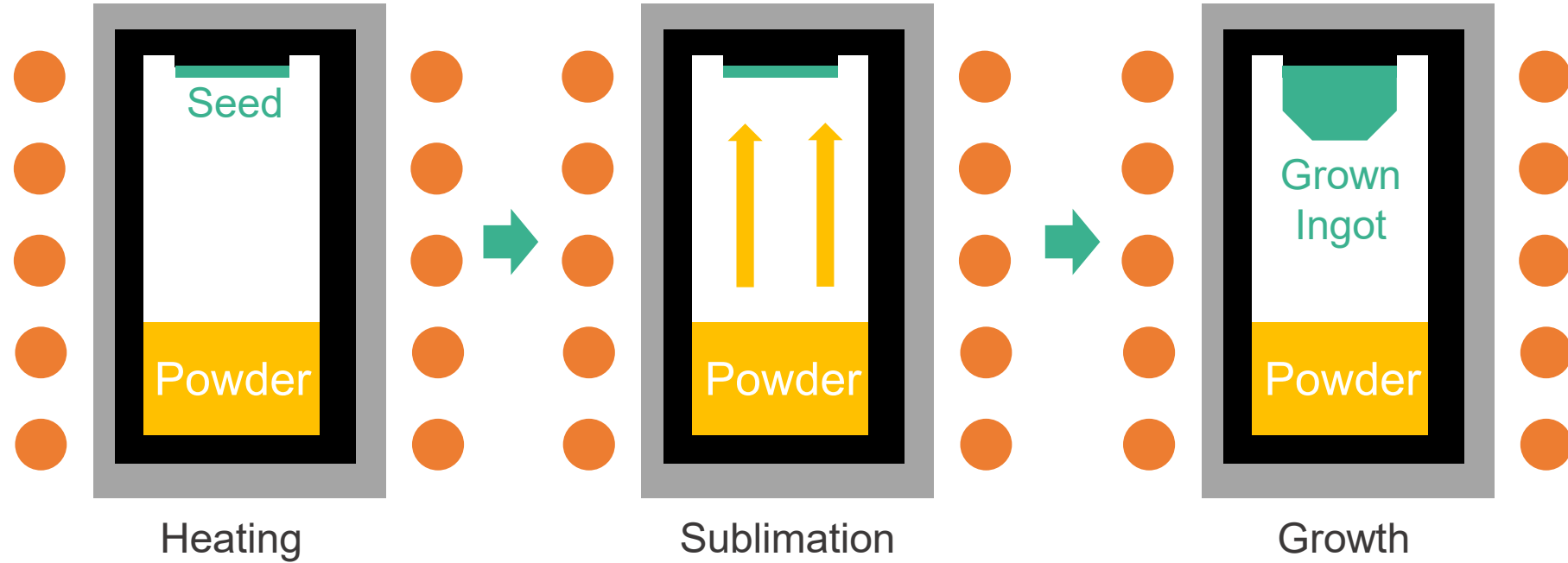
Application



PVT

PVT

- PVT (Physical Vapor Transport) is sublimation growth with seed and standard method for growing single crystal SiC



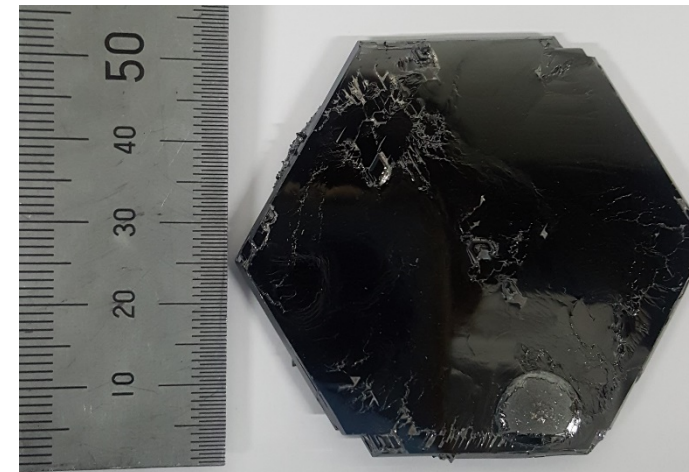
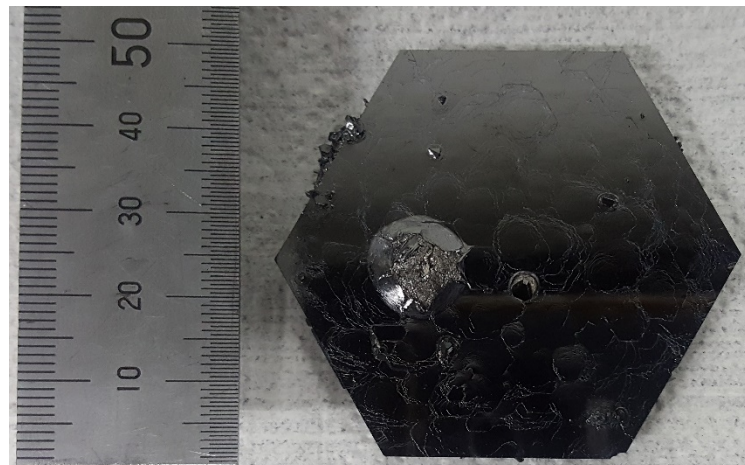
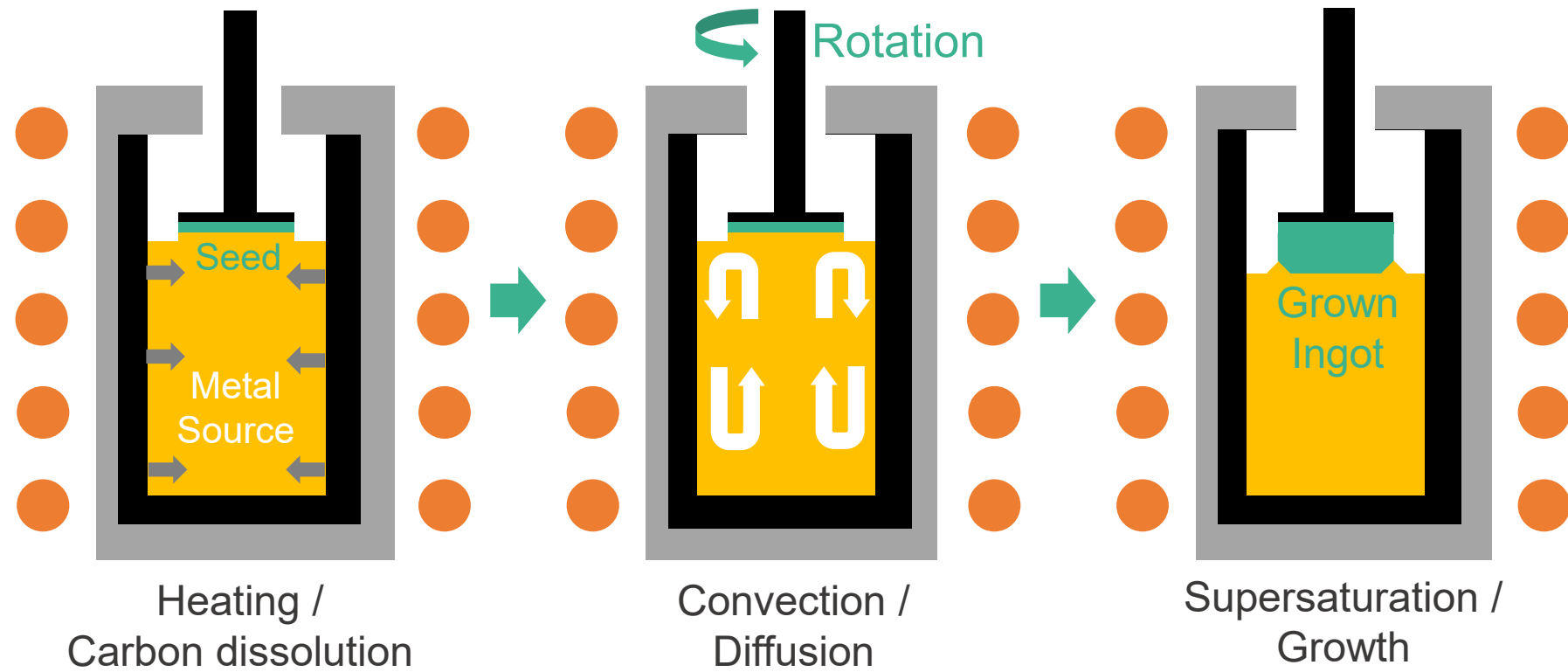
PVT grower

SiC Ingot

TSSG

TSSG

- TSSG (Top-Seeded Solution Growth) is alternative method growing high quality SiC crystal under a close condition to thermodynamic equilibrium state



SiC Ingot

Manufacturing Process

Source



Growing



Lateral Grinding



Multi-Wire Saw



Lapping



Grinding



Edge Grinder



Diamond Polishing



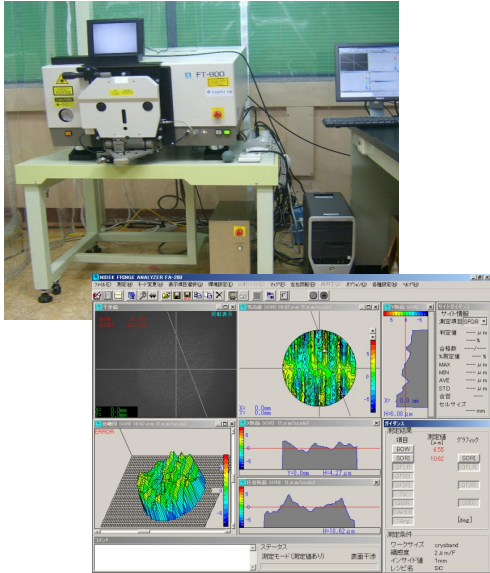
CMP



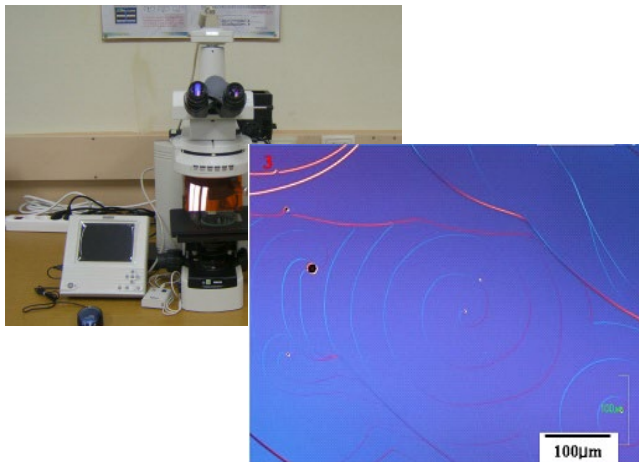
Wafer

Analysis system for Single Crystal

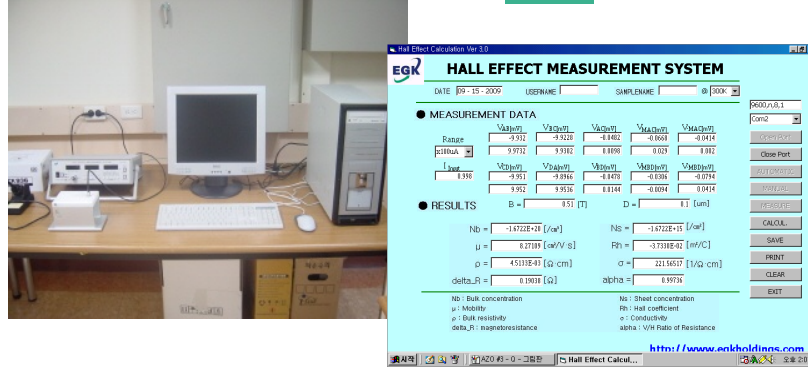
Flatness Tester



OM / Polarizer



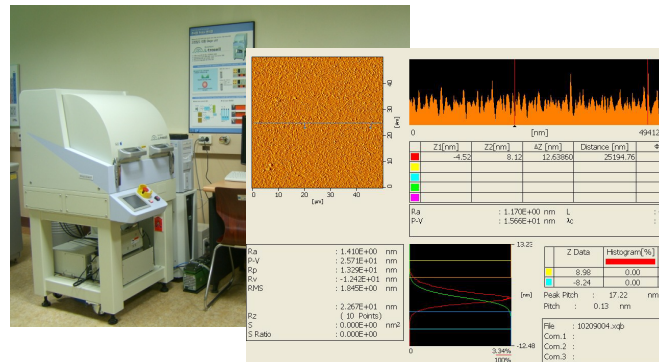
Hall Measure System



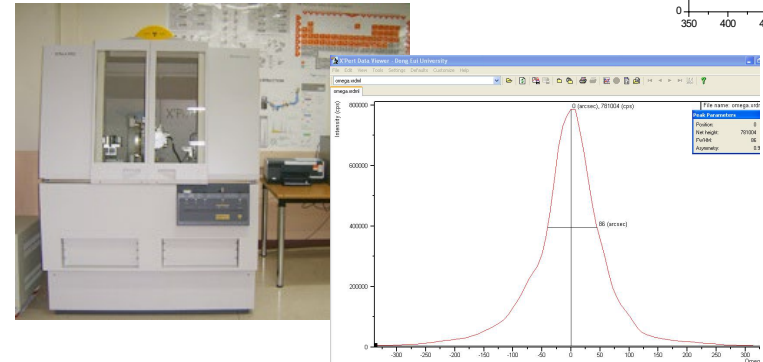
Single Crystal Wafer

- Flatness tester: wafer Bow/Sori
- HR-XRD: Rocking curve data
- FE-SEM/EDS: Microstructure, composition
- OM/Polarizer: Stress, Defect
- CL/PL: Defect
- Large Area AFM: Roughness
- Hall Measure System: Electrical data

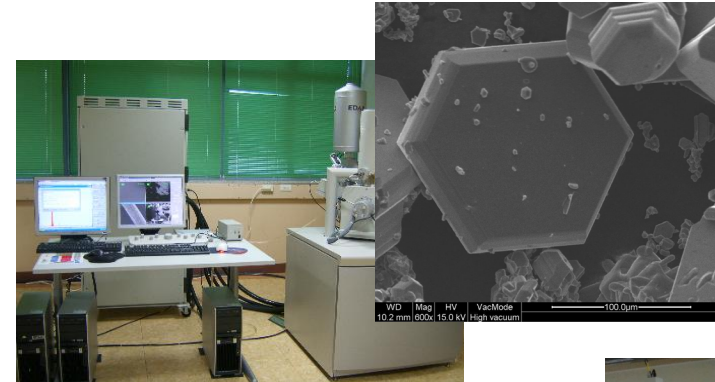
AFM



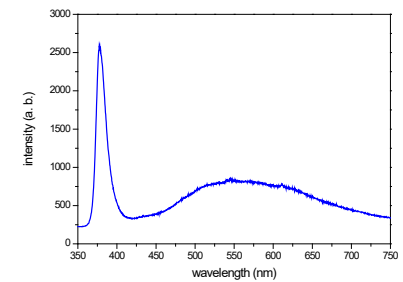
HR-XRD



FE-SEM / EDS



CL / PL



SiC Substrate

Doping

- N-type(N)
- P-type(Al, B)
- Semi-Insulating (V, High Purity)

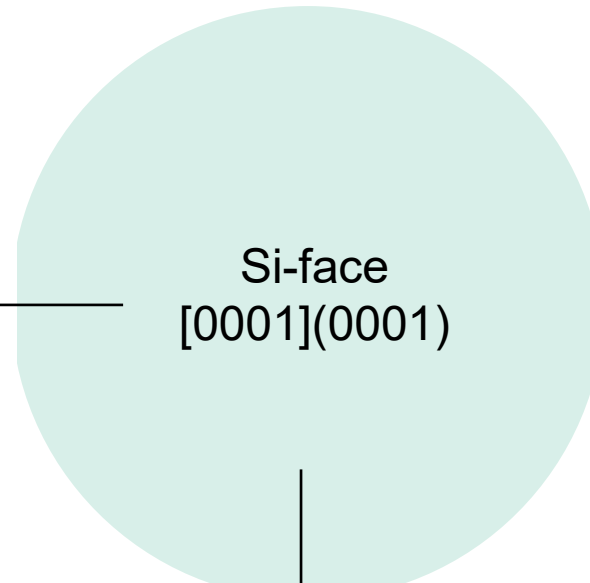
Surface

- Si-face, C-face
- Optical polish: single, double-side polish ($R_a \leq 3\text{nm}$)
- Standard polish: Epi ready ($R_a \leq 2\text{nm}$)
- CMP, Epi ready ($R_a \leq 1\text{nm}$)

Plane

- on-axis (c-axis)
- off-axis(4.0°-off, 8.0°-off)
- Positive Polarity : Si-face
- Negative Polarity : C-face
- Non-polar : a-plane, m-plane
- Semi-polar : r-plane

Secondary Flat
11-20



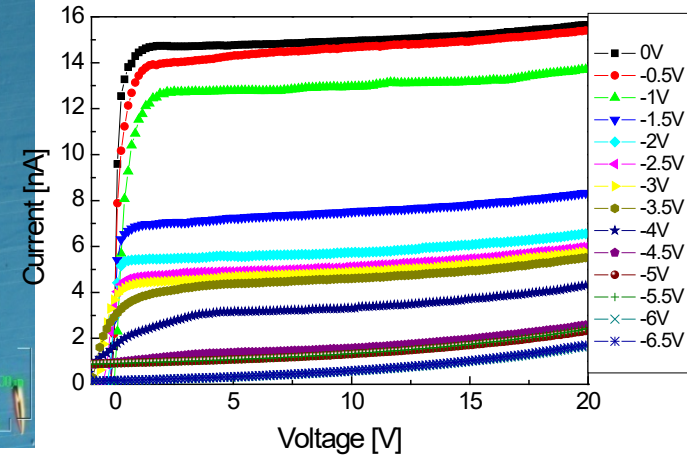
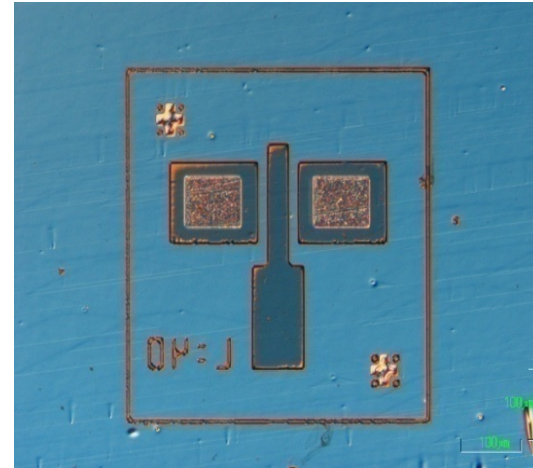
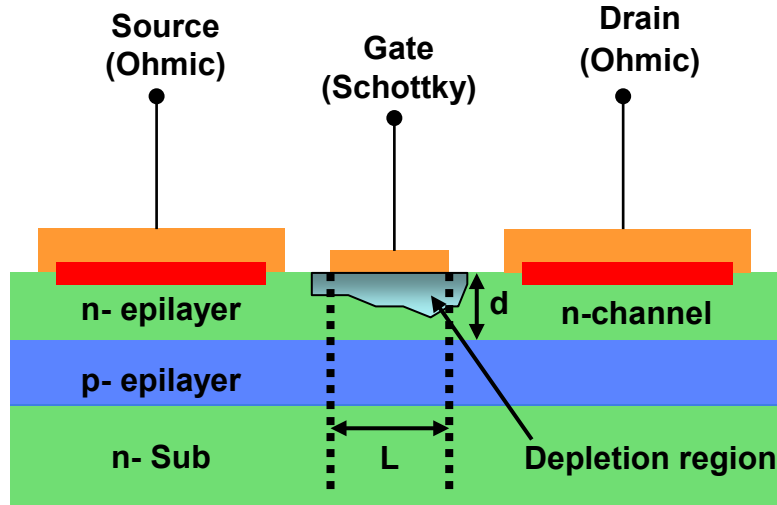
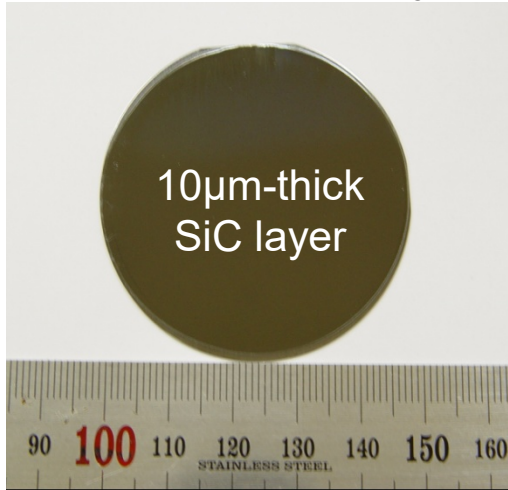
Primary Flat
1-100

Defect

- Micropipe (MP)
- Foreign Polytype
- Edge exclusion
- Dislocation
- Stacking Fault
- Bow
- Scratch

SiC Epitaxial Layer and MOSFET Device

2"-SiC epitaxial layer



Publications

- High Quality SiC Crystal with New Crucible Design, *Mater. Sci. Forum.* Vol. 527-529 (2006) 83-86.
- Epitaxial Growth of 4H-SiC (0001), *Mater. Sci. Forum.* Vol. 527-529 (2006) 267-270.
- Inserted Epitaxial Layer for High Quality SiC Single Crystal, *Mater. Sci. Forum.* Vol.556-557 (2007) 9-12
- Hydrogen Effect on SiC Single Crystal, *Mater. Sci. Forum.* Vol.556-557 (2007) 25-28
- p-type Epitaxial Layers using Various Si/Al ratios, *Mater. Sci. Forum.* Vol. 556-557 (2007) 153-156
- CMP Process Parameters of 6H-SiC(0001), *Mater. Sci. Forum.* Vol .600-603 (2009) 831-834
- Initial Stage Modification for 6H-SiC Crystal, *Mater. Sci. Forum.* Vol. 615-617 (2009) 7-10
- Seed Polarity Dependence of SiC Crystal Growth *J. Kor. Phys. Soc.* Vol.54, No.5 (2009) 1834-1839
- Non-polar SiC substrate, *Mater. Sci. Forum.* Vols. 645-648 (2010) pp 37-40
- a-plane (11-20) 6H-SiC Crystal Grown, *J. Korean Physical Society*, Vol. 58, No. 5 (2011) pp1541-1544
- Comparative study on dry etching of α - and β -SiC nano-pillars, *Materials Letters* 87 (2012) 9–12
- Modified Crucible Design and Seed Attachment , *Mater. Sci. Forum*, Vols. 740-742 (2013) pp 77-80

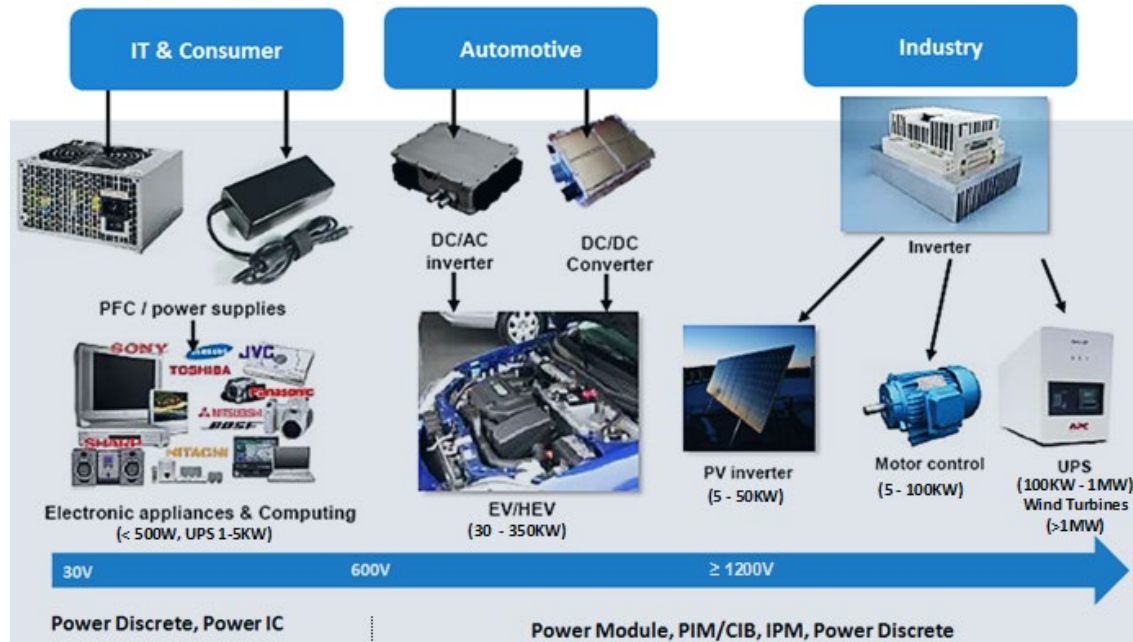
GaN Epitaxial Wafer

GaN

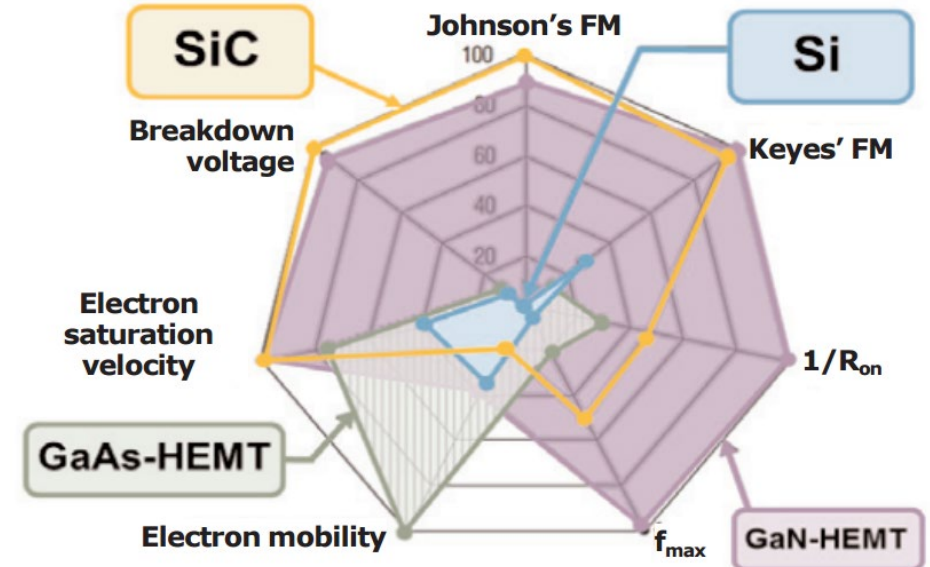
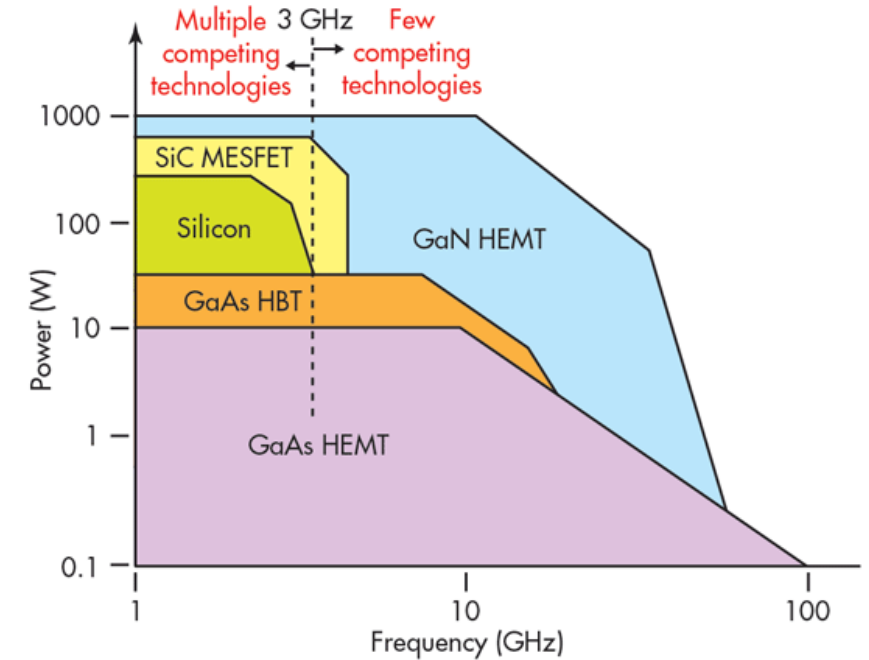
- GaN (Gallium Nitride), which is used in semiconductor power device as well as RF components and LEDs, enables high-speed, increase efficiency and higher power density

Application

Uses of GaN – Power Electronics



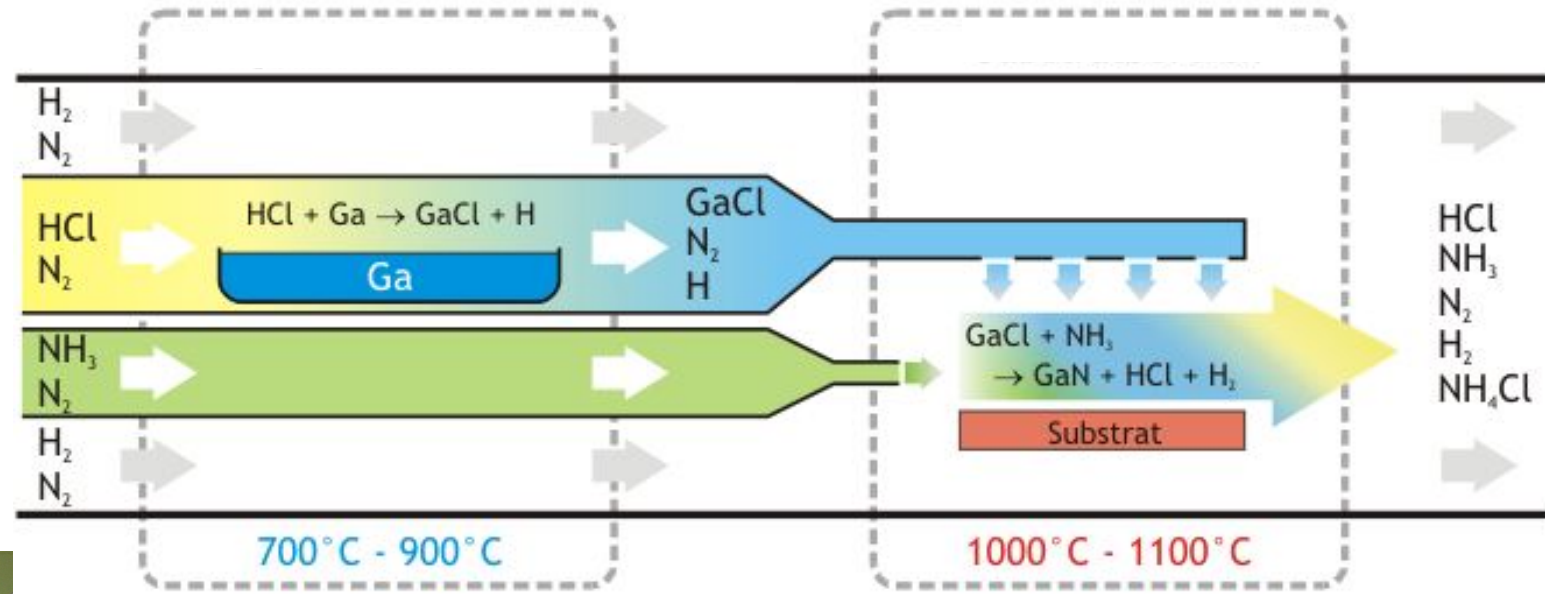
Advantage



HVPE system for GaN crystal growth

HVPE

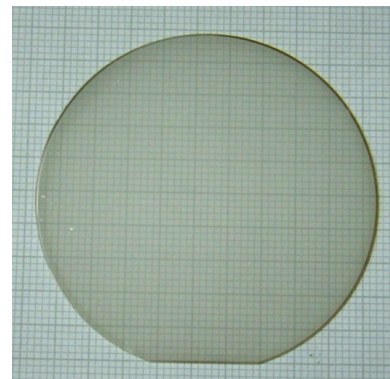
- HVPE (Hydride Vapor Phase Epitaxy), which is which gaseous metal chlorides react with ammonia to produce the group-III nitrides, is an epitaxial growth method such as GaN, GaAs and InP.



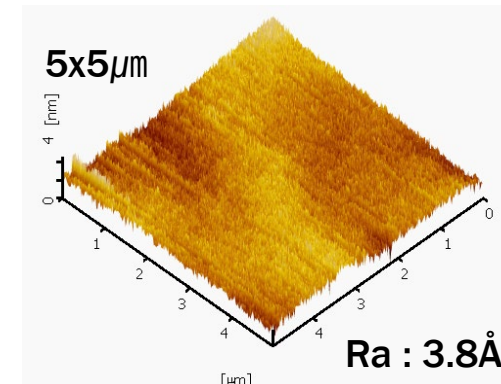
[Ref.] WIKIMEDIA COMMONS, https://commons.wikimedia.org/wiki/File:Schema_HVPE-Reaktor_de.png



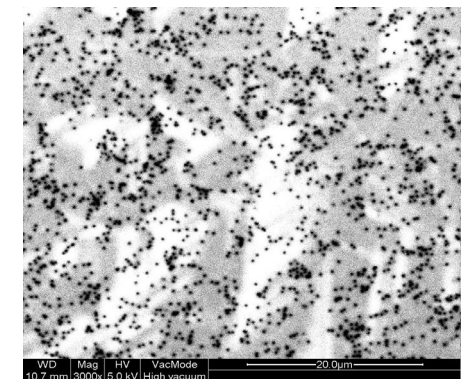
GaN on Sapphire
(2 inch)



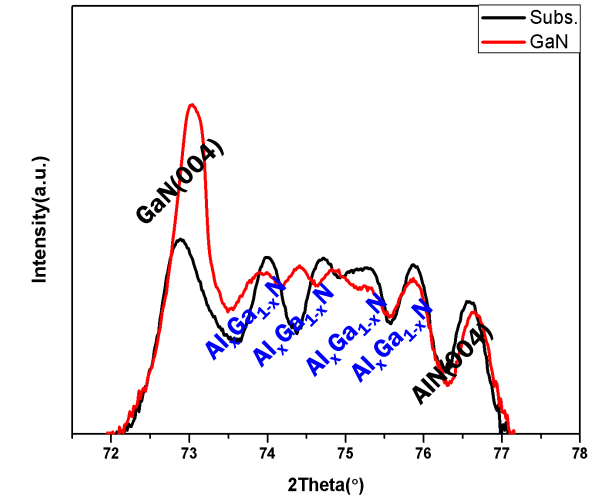
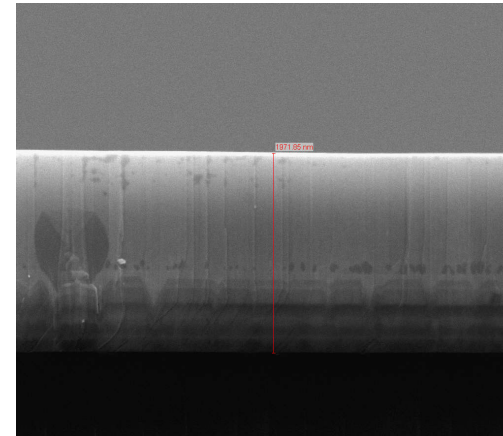
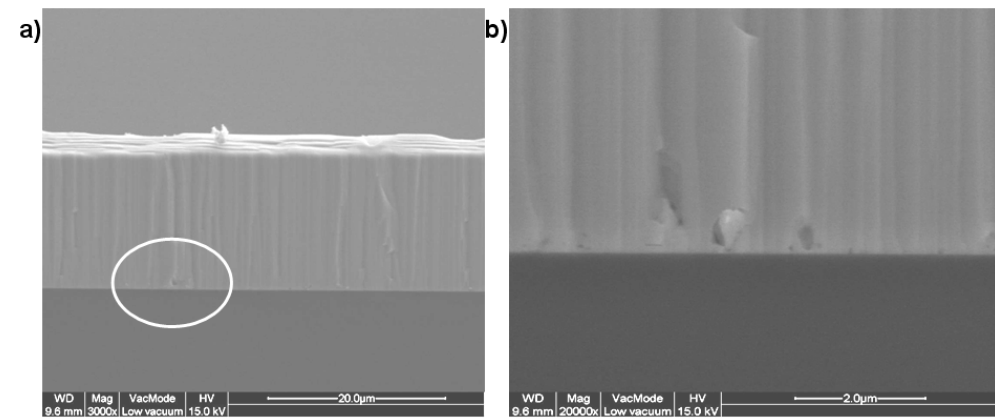
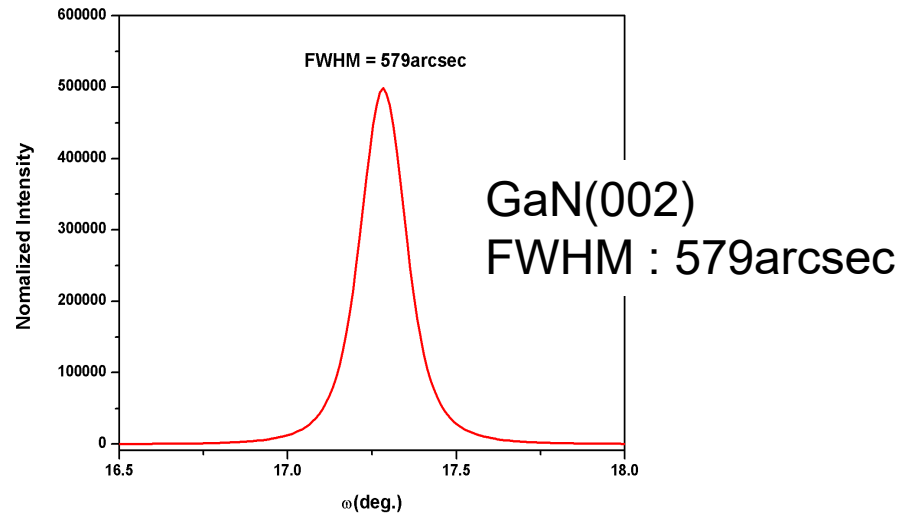
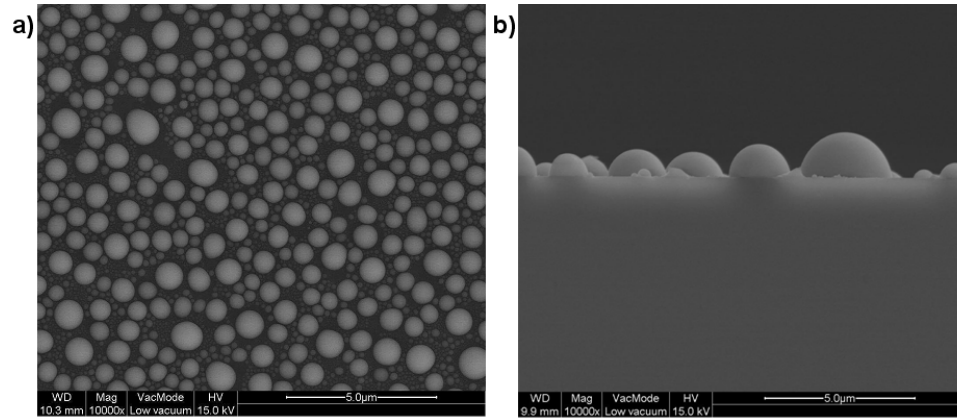
AFM data



Defect of GaN



GaN growth by HVPE method

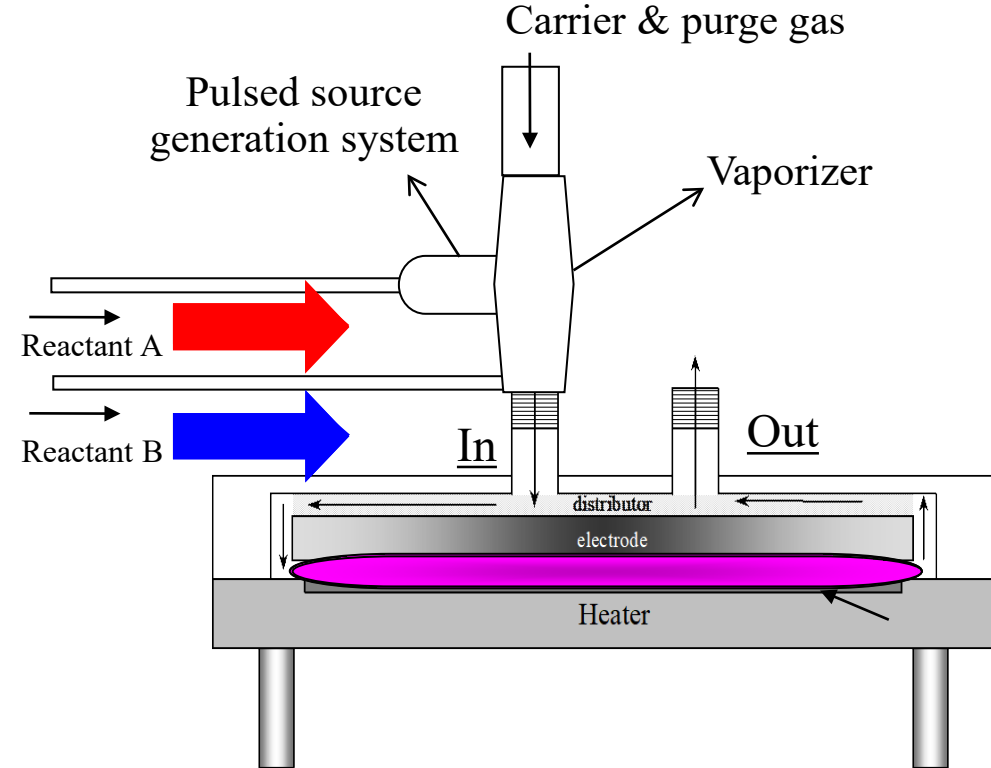


GaN/AlGaN buffer/Si Structure

Recent Publications

- GaN by HVPE technique, *Phys. Status. Solidi C* Vol. 7 (2010) 1770-1774
- GaN by HVPE and MOCVD methods, *Phys. Status. Solidi C* Vol. 7 (2010) 1794-1797
- Epitaxy of GaN on Si(111) substrate, *Journal of Crystal Growth*, (2013)

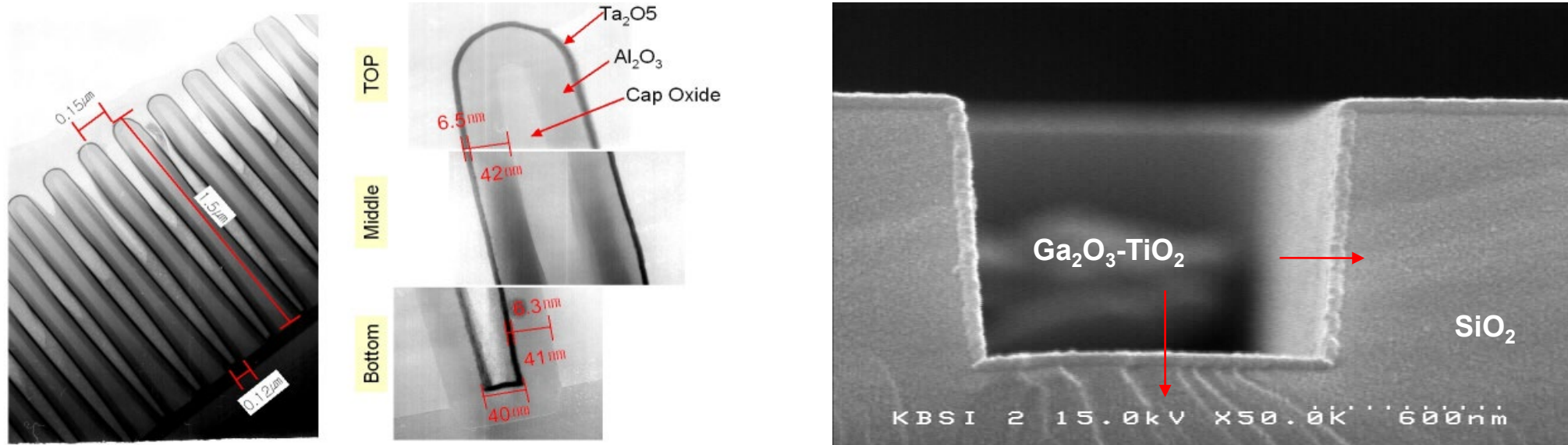
PEALD system for oxide films



Main specification

- 5-inch wafer loading
- RF generator for plasma enhancement
- Injector(Vaporizer) for liquid source

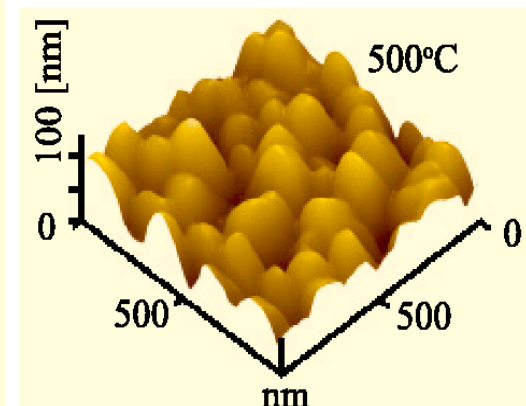
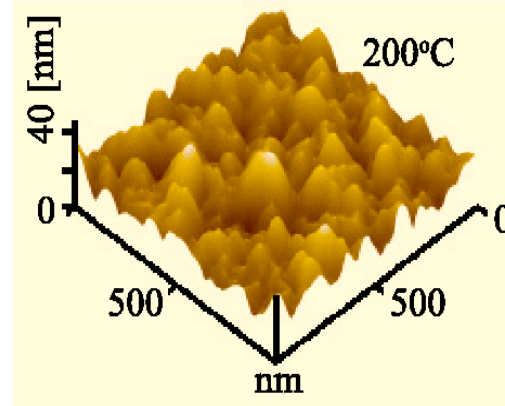
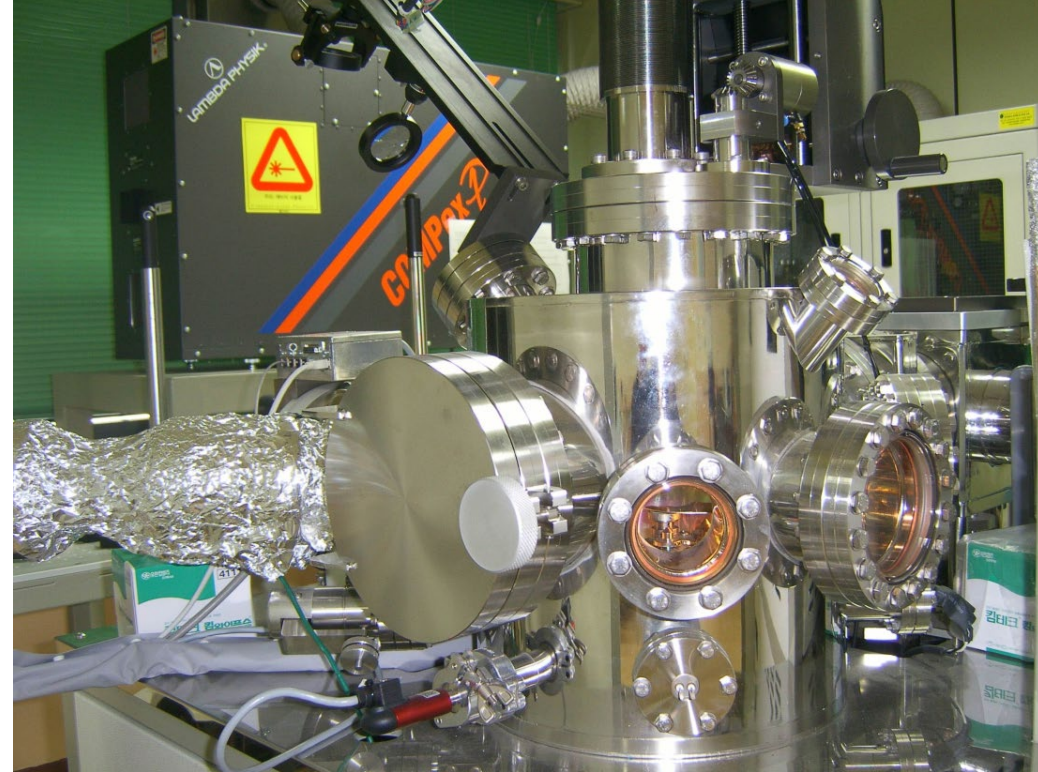
Dielectric thin films by PEALD / PLD



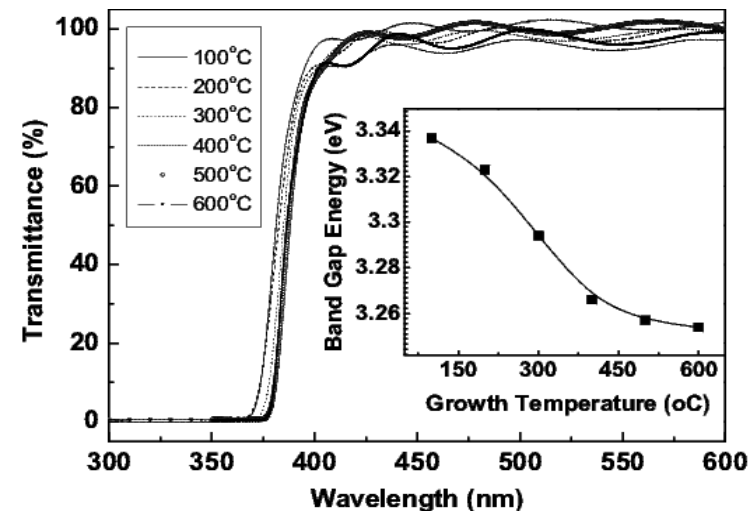
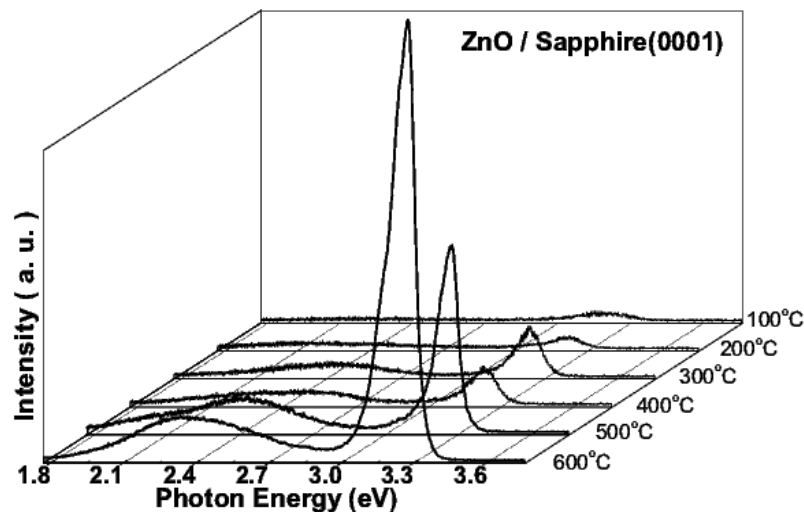
Recent Publications

- Gallium Oxide thin film, *J. Appl. Phys.* Vol. 98 (2005) 023504
- Ga₂O₃-TiO₂ nanomixed films, *Appl. Phys. Lett.* Vol.87 (2005) 082909
- Ga₂O₃-based thin films, *J. Electroceramics*, 17 (2-4) (2006) 145-149.
- Growth Temperature Dependence of TiO₂. *J. Korean Phys. Soc.* Vol. 50 (6) (2007) 1827-1832
- Al_{0.016}In_{0.003}Zn_{0.981}O by PLD, *J. Electrochemical Soc.*, Vol. 155, 10 (2008) H786-H790
- Bi₃NbO₇ Films by Nanocluster Deposition, *Electrochemical Solid-State Letter*, 12 (5) (2009) G23-G26
- ITO by NCD technique, *J. Electrochemical Soc.*, Vol. 157, 10 (2010) H937-H941
- Atomic layer deposition Al-doped ZnO films, *J. Appl. Phys.* 108, (2010) 043504
- 0.65Pb(Mg_{1/3}Nb_{2/3})O₃-0.35PbTiO₃ epitaxial films, *Sensors and Actuators B* 155 (2011) 854-858
- Structural and Optical Properties of TiO₂ Films on Glass Substrate, *Jpn J Appl Phys* 51 (2012) 09MF12
- Selective growth of pure magnetite thin films, nanowires, *J. Mater. Chem. C.*, (2013) 1, pp.1977-1982

PLD system for ZnO / doped-ZnO



ZnO / doped-ZnO Thin Films



Recent Publications

- Mg doped ZnO thin films and aging, *J. Appl. Phys.* Vol. 95(9) (2004) 4772-4776
- ZnO thin films on sapphire (0001) substrates *J. Electroceramics*. 13 (2004) 189-194
- Deep-level emission in ZnO thin films *Appl. Phys. Lett.* 86 (2005) 221910
- Transparent Conductive ZnO thin films on glass substrates *J. Crystal Growth*. 277 (2005) 284-292
- Stokes shift, blue shift and red shift of ZnO *J. Crystal Growth*. 291 (2006) 328-333.
- Ga:ZnO thin films on sapphire substrates *J. Electroceramics*, 17 (2-4) (2006) 287-292.
- In₂O₃-Doped ZnO Thin Films *J. Korean Phys. Soc.*, Vol. 50 (3) (2007) 626-631.
- The role of oxygen vacancies in epitaxial-deposited ZnO thin films. *J. Appl. Phys.* Vol. 101 (2007) 053106
- Na-Doped ZnO Thin Films, *J. Nanoscience and Nanotechnology*, Vol. 8, (2008) 5203-5207
- Boron and nitrogen co-doped ZnO Thin Films, *Ceramics International*, Vol. 34 (2008) 1011-1015
- Codoping in ZnO by AlN, *Vacuum* Vol. 83 (2009) 1081-1085
- Zn_{1-x}Cr_xO thin films, *J. Alloys Compd.* Vol.478 (2009) 45-48
- In-doped ZnO nanorods, *Appl. Phys. Lett.* Vol. 94, (2009) 041906
- ZnO/SiC, *J. Crystal Growth* Vol.312 (2010) 2393-2397



**Electronic
Material
Lab**

**Thank you
Questions & Comments !**